

RoHS Lab Analysis Report and Certification



Product Description: 8Ch 30KV 2.8V 4.4pF Diode Array MSOP-10
Product Number: SP4060-08ATG

This document hereby certifies that the aforementioned product and all its associated materials, are in compliance with RoHS Directive 2011/65/EU of the European Parliament and of the Council on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

Furthermore, it is hereby reported that the aforementioned product is composed of the following materials wherein valid Eu RoHS exemptions may be indicated as applicable.

Table 1. Product material composition and applicable RoHS exemption(s)

ICP ID	Raw Material Part Number	Raw Material Description	Applicable RoHS Exemption(s)
ICP-1333	-	Diode Wafer	
ICP-0335	CEL-9220HF	Epoxy Molding Compound	
ICP-0337	8006NS	Henkel	
ICP-0357	iCu, DHF, MaxSoft, MaxSoft2, MaxSoftLD and RelCu	Copper Bonding Wire	
ICP-0367	A194, C194	Red Coppery Copper Alloy	
ICP-0333	-	NiPdAu Plating	
ICP-2048	-	Silver Plating	

To view the third party RoHS validation report of these materials, see download procedure below.

1. Open the FTP website on your windows explorer: ftp://pubftp.littelfuse.com/ICP_Test_Reports/
2. Retrieve the username and password thru your corresponding Sales / FAE or email envrequests@littelfuse.com
3. Find the corresponding ICP ID and download the corresponding ICP report.

Issued by:



Jennilyn R. Dinglasan
 Global EHS Supervisor



Noted by: Arsenio M. Cesista, Jr.
 Global EHS Manager